## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## MC14093B

## Quad 2-Input "NAND" Schmitt Trigger

The MC14093B Schmitt trigger is constructed with MOS P -channel and N -channel enhancement mode devices in a single monolithic structure. These devices find primary use where low power dissipation and/or high noise immunity is desired. The MC14093B may be used in place of the MC14011B quad 2-input NAND gate for enhanced noise immunity or to "square up" slowly changing waveforms.

## Features

- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- Triple Diode Protection on All Inputs
- Pin-for-Pin Compatible with CD4093
- Can be Used to Replace MC14011B
- Independent Schmitt-Trigger at each Input
- NLV Prefix for Automotive and Other Applications Requiring

Unique Site and Control Change Requirements; AEC-Q100
Qualified and PPAP Capable

- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to $\mathrm{V}_{\mathrm{SS}}$ )

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | DC Supply Voltage Range | -0.5 to +18.0 | V |
| $\mathrm{~V}_{\text {in }}, \mathrm{V}_{\text {out }}$ | Input or Output Voltage Range <br> (DC or Transient) | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| $\mathrm{I}_{\text {in }}, \mathrm{I}_{\text {out }}$ | Input or Output Current <br> (DC or Transient) per Pin | $\pm 10$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation, <br> per Package (Note 1) | 500 | mW |
| $\mathrm{~T}_{\mathrm{A}}$ | Ambient Temperature Range | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Temperature <br> (8-Second Soldering) | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: $-7.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ From $65^{\circ} \mathrm{C}$ To $125^{\circ} \mathrm{C}$

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, $\mathrm{V}_{\text {in }}$ and $\mathrm{V}_{\text {out }}$ should be constrained to the range $\mathrm{V}_{\text {SS }} \leq\left(\mathrm{V}_{\text {in }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{DD}}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either $\mathrm{V}_{S S}$ or $\mathrm{V}_{\mathrm{DD}}$ ). Unused outputs must be left open.

ON Semiconductor ${ }^{\circledR}$
http://onsemi.com


## MARKING DIAGRAMS



SOIC-14


SOEIAJ-14

A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or • = Pb-Free Package
(Note: Microdot may be in either location)
ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

## LOGIC DIAGRAM





$V_{D D}=$ PIN 14
$\mathrm{V}_{\text {SS }}=\mathrm{PIN} 7$

## EQUIVALENT CIRCUIT SCHEMATIC

(1/4 OF CIRCUIT SHOWN)


ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| MC14093BDG | SOIC-14 <br> (Pb-Free) | 55 Units / Rail |
| NLV14093BDG* | SOIC-14 <br> (Pb-Free) | 55 Units / Rail |
| MC14093BDR2G | SOIC-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| NLV14093BDR2G* | SOIC-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| MC14093BDTR2G | TSSOP-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| NLV14093BDTR2G* | TSSOP-14 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| MC14093BFELG | SOEIAJ-14 <br> (Pb-Free) | 2000 Units / Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to $\mathrm{V}_{\mathrm{SS}}$ )

| Characteristic | Symbol | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{Vdc} \end{aligned}$ | $-55^{\circ} \mathrm{C}$ |  | $25^{\circ} \mathrm{C}$ |  |  | $125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Typ (Note 2) | Max | Min | Max |  |
| Output Voltage <br> "0" Level $V_{\text {in }}=V_{D D} \text { or } 0$ | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ |  | $\begin{aligned} & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | Vdc |
| "1" Level $V_{\text {in }}=0 \text { or } V_{D D}$ | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | - | $\begin{gathered} 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{gathered} 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | - | Vdc |
| $\begin{array}{\|lll} \hline \text { Output Drive Current } & \\ \left(\mathrm{V}_{\mathrm{OH}}=2.5 \mathrm{Vdc}\right) & \text { Source } \\ \left(\mathrm{V}_{\mathrm{OH}}=4.6 \mathrm{Vdc}\right) & \\ \left(\mathrm{VOH}_{\mathrm{OH}}=9.5 \mathrm{Vdc}\right) & \\ \left(\mathrm{V}_{\mathrm{OH}}=13.5 \mathrm{Vdc}\right) & \end{array}$ | ${ }^{\text {IOH }}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} -3.0 \\ -0.64 \\ -1.6 \\ -4.2 \end{gathered}$ |  | $\begin{aligned} & -2.4 \\ & -0.51 \\ & -1.3 \\ & -3.4 \end{aligned}$ | $\begin{gathered} -4.2 \\ -0.88 \\ -2.25 \\ -8.8 \end{gathered}$ | - | $\begin{aligned} & -1.7 \\ & -0.36 \\ & -0.9 \\ & -2.4 \end{aligned}$ |  | mAdc |
| $\begin{array}{ll} \left(\mathrm{V}_{\mathrm{OL}}=0.4 \mathrm{Vdc}\right) & \text { Sink } \\ \left(\mathrm{V}_{\mathrm{OL}}=0.5 \mathrm{Vdc}\right) & \\ \left(\mathrm{V}_{\mathrm{OL}}=1.5 \mathrm{Vdc}\right) & \end{array}$ | loL | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 0.64 \\ 1.6 \\ 4.2 \end{gathered}$ |  | $\begin{gathered} \hline 0.51 \\ 1.3 \\ 3.4 \end{gathered}$ | $\begin{gathered} \hline 0.88 \\ 2.25 \\ 8.8 \end{gathered}$ |  | $\begin{gathered} 0.36 \\ 0.9 \\ 2.4 \end{gathered}$ | - | mAdc |
| Input Current | $\mathrm{l}_{\text {in }}$ | 15 | - | $\pm 0.1$ | - | $\pm 0.00001$ | $\pm 0.1$ | - | $\pm 1.0$ | $\mu \mathrm{Adc}$ |
| Input Capacitance $\left(\mathrm{V}_{\mathrm{in}}=0\right)$ | $\mathrm{C}_{\text {in }}$ | - | - | - | - | 5.0 | 7.5 | - | - | pF |
| Quiescent Current (Per Package) | $I_{\text {DD }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{gathered} \hline 0.25 \\ 0.5 \\ 1.0 \end{gathered}$ | - | $\begin{aligned} & \hline 0.0005 \\ & 0.0010 \\ & 0.0015 \end{aligned}$ | $\begin{gathered} \hline 0.25 \\ 0.5 \\ 1.0 \end{gathered}$ | - | $\begin{aligned} & 7.5 \\ & 15 \\ & 30 \end{aligned}$ | $\mu \mathrm{Adc}$ |
| Total Supply Current (Notes 3 \& 4) (Dynamic plus Quiescent, Per Package) ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ on all outputs, all buffers switching) | $\mathrm{I}^{\text {T }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & I_{T}=(1.2 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \\ & \mathrm{I}_{\mathrm{T}}=(2.4 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \\ & \mathrm{I}_{\mathrm{T}}=(3.6 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{I}+\mathrm{I}_{\mathrm{DD}} \end{aligned}$ |  |  |  |  |  |  | $\mu \mathrm{Adc}$ |
| Hysteresis Voltage | $\mathrm{V}_{\mathrm{H}}{ }^{\dagger}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 0.3 \\ & 1.2 \\ & 1.6 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.4 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 0.3 \\ & 1.2 \\ & 1.6 \end{aligned}$ | $\begin{aligned} & \hline 1.1 \\ & 1.7 \\ & 2.1 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.4 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 0.3 \\ & 1.2 \\ & 1.6 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.4 \\ & 5.0 \end{aligned}$ | Vdc |
| Threshold Voltage Positive-Going | $\mathrm{V}_{\text {T+ }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 2.2 \\ & 4.6 \\ & 6.8 \end{aligned}$ | $\begin{gathered} 3.6 \\ 7.1 \\ 10.8 \end{gathered}$ | $\begin{aligned} & 2.2 \\ & 4.6 \\ & 6.8 \end{aligned}$ | $\begin{aligned} & 2.9 \\ & 5.9 \\ & 8.8 \end{aligned}$ | $\begin{gathered} 3.6 \\ 7.1 \\ 10.8 \end{gathered}$ | $\begin{aligned} & 2.2 \\ & 4.6 \\ & 6.8 \end{aligned}$ | $\begin{gathered} 3.6 \\ 7.1 \\ 10.8 \end{gathered}$ | Vdc |
| Negative-Going | $\mathrm{V}_{\text {T- }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 2.5 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 2.8 \\ & 5.2 \\ & 7.4 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 2.5 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 3.9 \\ & 5.8 \end{aligned}$ | $\begin{aligned} & 2.8 \\ & 5.2 \\ & 7.4 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 2.5 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 2.8 \\ & 5.2 \\ & 7.4 \end{aligned}$ | Vdc |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
3. The formulas given are for the typical characteristics only at $25^{\circ} \mathrm{C}$.
4. To calculate total supply current at loads other than 50 pF :

$$
I_{T}\left(C_{L}\right)=I_{T}(50 \mathrm{pF})+\left(C_{L}-50\right) V f k
$$

where: $\mathrm{I}_{\mathrm{T}}$ is in $\mu \mathrm{A}$ (per package), $\mathrm{C}_{\mathrm{L}}$ in $\mathrm{pF}, \mathrm{V}=\left(\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{\mathrm{SS}}\right)$ in volts, f in kHz is input frequency, and $\mathrm{k}=0.004$.

SWITCHING CHARACTERISTICS ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Characteristic | Symbol | $V_{D D}$ Vdc | Min | $\begin{aligned} & \text { Typ } \\ & \text { (Note 5) } \end{aligned}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Rise Time | ${ }_{\text {t }}^{\text {tin }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 100 \\ & 50 \\ & 40 \end{aligned}$ | $\begin{gathered} \hline 200 \\ 100 \\ 80 \end{gathered}$ | ns |
| Output Fall Time | ${ }_{\text {t }}$ HL | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & \hline 100 \\ & 50 \\ & 40 \end{aligned}$ | $\begin{gathered} \hline 200 \\ 100 \\ 80 \end{gathered}$ | ns |
| Propagation Delay Time | $\mathrm{t}_{\text {PLH }}$, tPHL | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 125 \\ & 50 \\ & 40 \end{aligned}$ | $\begin{gathered} 250 \\ 100 \\ 80 \end{gathered}$ | ns |

5. Data labeled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.


Figure 1. Switching Time Test Circuit and Waveforms


Figure 2. Typical Schmitt Trigger Applications

## MC14093B




Figure 4. Typical Output Sink Characteristics Test Circuit


Figure 5. Typical Transfer Characteristics

## MC14093B

## PACKAGE DIMENSIONS



MC14093B

## PACKAGE DIMENSIONS

TSSOP-14
CASE 948G
ISSUE B

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## PACKAGE DIMENSIONS

## SOEIAJ-14

CASE 965
ISSUE B


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE

MOLD FLASH OR PROTRUSIONS AND ARE
MEASURED AT THE PARTING LINE. MOLD FLASH
OR PROTRUSIONS SHALL NOT EXCEED 0.15
(0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 ( 0.003 ) DAMBAR PROTRUSION SHALL BE 0.08 (0.
TOTAL IN EXCESS OF THE LEAD WIDTH
TOTAL IN EXCESS OF THE LEAD WIDTH
DIMENSION AT MAXIMUM MATERIAL CONDITION.
DIMENSION AT MAXIMUM MATERIAL CONDITION.
DAMBAR CANNOT BE LOCATED ON THE LOWER DAMBAR CANNOT BE LOCATED ON THE L
RADIUS OR THE FOOT. MINIMUM SPACE RADIUS OR THE FOOT. MINIMUM SPACE
BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 ( 0.018).

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | --- | 2.05 | --- | 0.081 |
| $\mathrm{A}_{1}$ | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 9.90 | 10.50 | 0.390 | 0.413 |
| E | 5.10 | 5.45 | 0.201 | 0.215 |
| e | 1.27 BSC |  | 0.050 BSC |  |
| $\mathrm{H}_{\mathrm{E}}$ | 7.40 | 8.20 | 0.291 | 0.323 |
| L | 0.50 | 0.85 | 0.020 | 0.033 |
| LE | 1.10 | 1.50 | 0.043 | 0.059 |
| M | $0^{\circ}$ | $10^{\circ}$ | $0^{\circ}$ | $10^{\circ}$ |
| $Q_{1}$ | 0.70 | 0.90 | 0.028 | 0.035 |
| Z | --- | 1.42 | --- | 0.056 |

> ON Semiconductor and the one are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

## LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com
N. American Technical Support: 800-282-9855 Toll Free

USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421337902910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: http://www.onsemi.com/orderlit
For additional information, please contact your local Sales Representative

